

**ANDERSON KILL & OLICK, P.C.**  
**DECLARATION AND POWER OF ATTORNEY**

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed at 201 below), or an original, first and joint inventor (if plural names are listed at 201 et seq. below), of the subject matter which is claimed and for which a patent is sought on the invention entitled **METHOD FOR FORMING A MICRO-PATTERN ON A SUBSTRATE BY USING CAPILLARY FORCE** the specification of which:

[ x ] is attached hereto

[ ] was filed on \_\_\_\_\_ as Application Serial No. \_\_\_\_\_ (for declaration not accompanying application)  
with amendment(s) filed on \_\_\_\_\_ (if applicable)

[ ] was filed as PCT International Application Serial No. \_\_\_\_\_ on \_\_\_\_\_ and was  
amended under PCT Article 19 on \_\_\_\_\_ (if applicable)

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, §1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, §119/§172 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

EARLIEST FOREIGN APPLICATION(S), IF ANY, FILED PRIOR TO THE FILING DATE OF THE APPLICATION			
APPLICATION NUMBER	COUNTRY	DATE OF FILING (day, month, year)	PRIORITY CLAIMED UNDER 35 U.S.C. 119/172
			YES [ ] NO [ ]
			YES [ ] NO [ ]
			YES [ ] NO [ ]

I hereby claim the benefit under Title 35, PCT application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior PCT application in the manner provided by the first paragraph of Title 35, United States Code §112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, §1.56(a) which occurred between the filing date of the prior PCT application and the national filing date of this application:

APPLICATION NUMBER	FILING DATE	STATUS		
		PATENTED	PENDING	ABANDONED

POWER OF ATTORNEY. As a named inventor, I hereby appoint Michael N. Meller (Reg. No. 20,779), Eugene Lieberstein (Reg. No. 24,645), Richard B. Klar (Reg. No. 31,385) and Jack Matalon (Reg. No. 22,441) whose address is **Anderson Kill & Olick, P.C., 1251 Avenue of the Americas, New York, New York 10020-1182**, as my attorneys, to prosecute this application, and to transact all business in the Patent and Trademark Office connected therewith.

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

SIGNATURE OF INVENTOR 201 <i>Hong Hie Lee</i>		SIGNATURE OF INVENTOR 202 <i>Kab Yang Suh</i>	
DATE <i>September 10, 2001</i>		DATE <i>September 10, 2001</i>	
SIGNATURE OF INVENTOR 203 <i>Youn Sang KIM</i>		SIGNATURE OF INVENTOR 204 <i>Pil Jin Yoo</i>	
DATE <i>September 10, 2001</i>		DATE <i>September 10, 2001</i>	